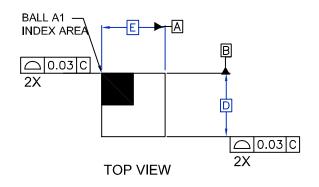
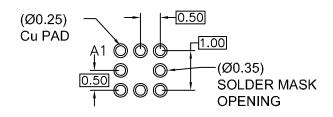
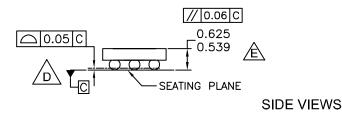
WLCSP8 1.57x1.57x0.582 CASE 567PZ ISSUE O

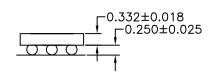
DATE 31 OCT 2016





RECOMMENDED LAND PATTERN (NSMD)





NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C, DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
- DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E. PACKAGE TYPICAL HEIGHT IS 582 MICRONS ± 43 MICRONS (539-625 MICRONS).
- F FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
 - G. BALL COMPOSITION: Sn95.5-Ag3.9-Cu0.6

→	(X)+/018
0.50	⊕ Ø0.005 © C A B - 8 × Ø0.315 +/025
0.50 0 0	C B -(Y)+/018 A'
BOTTOM V	IEW

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